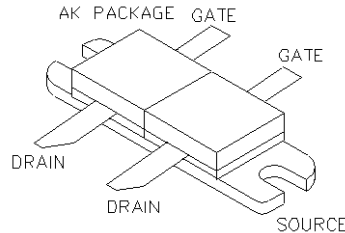




### General Description

Silicon VDMOS and LDMOS transistors designed specifically for broadband RF applications. Suitable for Military Radios, Cellular and Paging Amplifier Base Stations, Broadcast FM/AM, MRI, Laser Driver and others.

"Polyfet"™ process features low feedback and output capacitances resulting in high  $F_t$  transistors with high input impedance and high efficiency.



### SILICON GATE ENHANCEMENT MODE

### RF POWER LDMOS TRANSISTOR

45.0 Watts Push - Pull

Package Style AK

HIGH EFFICIENCY, LINEAR  
HIGH GAIN, LOW NOISE

### ABSOLUTE MAXIMUM RATINGS ( $T = 25^{\circ}\text{C}$ )

Total Device Dissipation	Junction to Case Thermal Resistance	Maximum Junction Temperature	Storage Temperature	DC Drain Current	Drain to Gate Voltage	Drain to Source Voltage	Gate to Source Voltage
140 Watts	1.10 $^{\circ}\text{C/W}$	200 $^{\circ}\text{C}$	-65 $^{\circ}\text{C}$ to 150 $^{\circ}\text{C}$	8.5 A	70V	70V	20 V

### RF CHARACTERISTICS ( 45.0 WATTS OUTPUT )

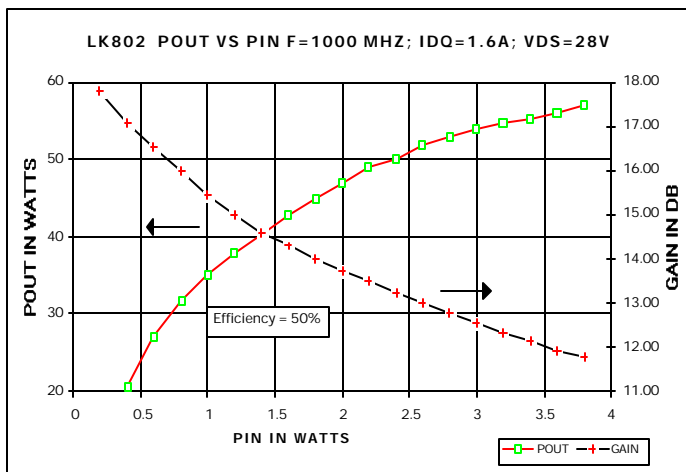
SYMBOL	PARAMETER	MIN	TYP	MAX	UNITS	TEST CONDITIONS
Gps	Common Source Power Gain	12			dB	$I_{dq} = 0.80 \text{ A}$ , $V_{ds} = 28.0 \text{ V}$ , $F = 1,000 \text{ MHz}$
$\eta$	Drain Efficiency		50		%	$I_{dq} = 0.80 \text{ A}$ , $V_{ds} = 28.0 \text{ V}$ , $F = 1,000 \text{ MHz}$
VSWR	Load Mismatch Tolerance			20:1	Relative	$I_{dq} = 0.80 \text{ A}$ , $V_{ds} = 28.0 \text{ V}$ , $F = 1,000 \text{ MHz}$

### ELECTRICAL CHARACTERISTICS ( EACH SIDE )

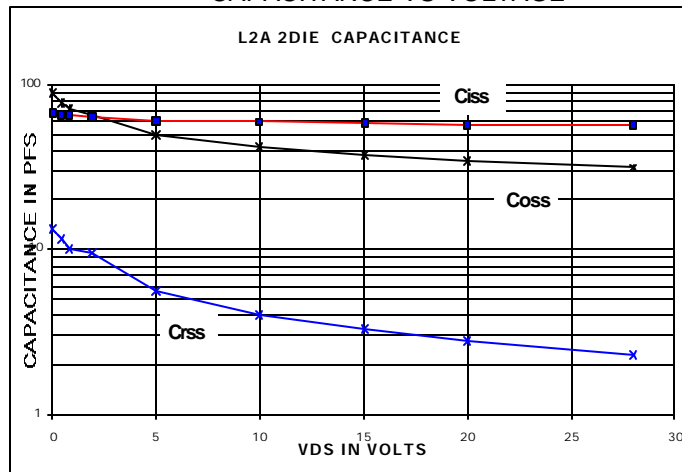
SYMBOL	PARAMETER	MIN	TYP	MAX	UNITS	TEST CONDITIONS
Bvdss	Drain Breakdown Voltage	65			V	$I_{ds} = 0.20 \text{ mA}$ , $V_{gs} = 0\text{V}$
Idss	Zero Bias Drain Current			2.0	mA	$V_{ds} = 28.0 \text{ V}$ , $V_{gs} = 0\text{V}$
Igss	Gate Leakage Current			1	uA	$V_{ds} = 0\text{V}$ $V_{gs} = 30\text{V}$
Vgs	Gate Bias for Drain Current	1		7	V	$I_{ds} = 0.20 \text{ A}$ , $V_{gs} = V_{ds}$
gM	Forward Transconductance		1.6		Mho	$V_{ds} = 10\text{V}$ , $V_{gs} = 5\text{V}$
Rdson	Saturation Resistance		0.50		Ohm	$V_{gs} = 20\text{V}$ , $I_{ds} = 5.00 \text{ A}$
Idsat	Saturation Current		11.00		Amp	$V_{gs} = 20\text{V}$ , $V_{ds} = 10\text{V}$
Ciss	Common Source Input Capacitance		60.0		pF	$V_{ds} = 28.0 \text{ V}$ , $V_{gs} = 0\text{V}$ , $F = 1 \text{ MHz}$
Crss	Common Source Feedback Capacitance		2.0		pF	$V_{ds} = 28.0 \text{ V}$ , $V_{gs} = 0\text{V}$ , $F = 1 \text{ MHz}$
Coss	Common Source Output Capacitance		30.0		pF	$V_{ds} = 28.0 \text{ V}$ , $V_{gs} = 0\text{V}$ , $F = 1 \text{ MHz}$

# LK802

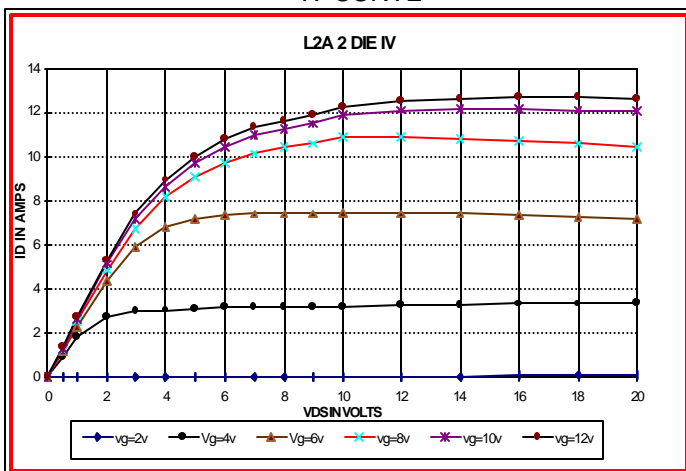
POUT VS PIN GRAPH



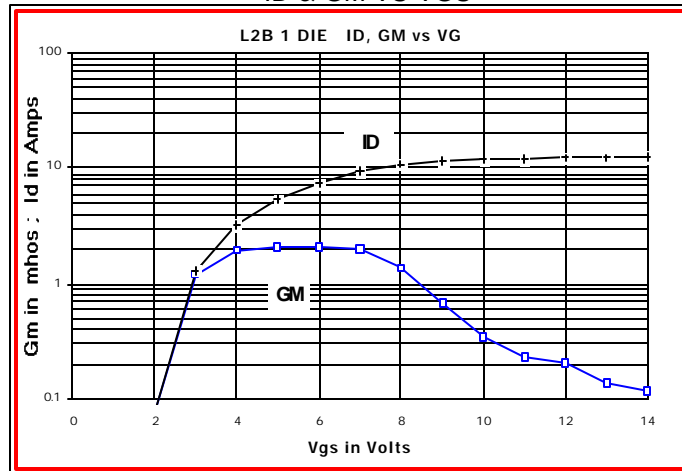
CAPACITANCE VS VOLTAGE



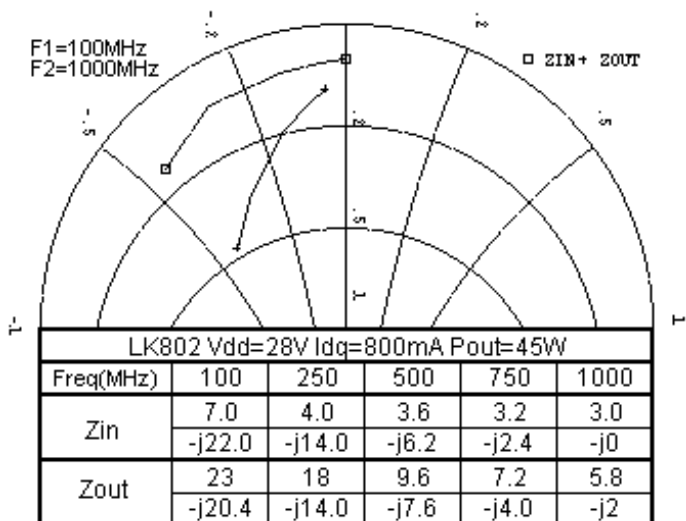
IV CURVE



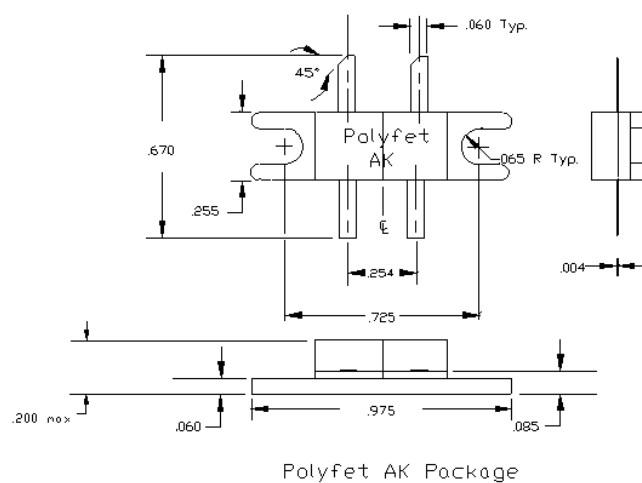
ID & GM VS VGS



Zin Zout



PACKAGE DIMENSIONS IN INCHES



Tolerance .XX +/-0.01 .XXX +/- .005 inches

POLYFET RF DEVICES

REVISION 04/27/2001

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